TPS3800-xx



SLVS219E - AUGUST 1999-REVISED OCTOBER 2010

# **ULTRA-SMALL SUPPLY VOLTAGE SUPERVISORS**

Check for Samples: TPS3800-xx, TPS3801-xx, TPS3802-xx

#### **FEATURES**

- Small, 5-Pin SC-70 (SOT-323) Package
- Supply Current of 9 µA
- **Power-On Reset Generator With Fixed Delay** Time
  - TPS3800 = 100 ms
  - TPS3801 = 200 ms
  - TPS3802 = 400 ms
- Precision Supply Voltage Monitor 1.8 V, 2.5 V, 2.7 V, 3 V, 3.3 V, 5 V, and Adjustable
- Manual Reset Input (Except TPS3801-01)
- Temperature Range: -40°C to +85°C

#### **APPLICATIONS**

- Applications Using DSPs, Microcontrollers, or **Microprocessors**
- **Wireless Communication Systems**
- Portable/Battery-Powered Equipment
- **Programmable Controls**
- **Intelligent Instruments**
- **Industrial Equipment**
- **Notebook/Desktop Computers**
- **Automotive Systems**

#### DESCRIPTION

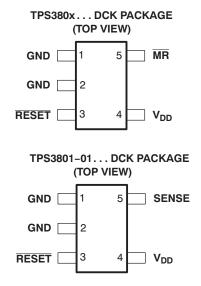
The TPS380x family of supervisory circuits monitor supply voltages to provide circuit initialization and timing supervision, primarily for DSPs and other processor-based systems.

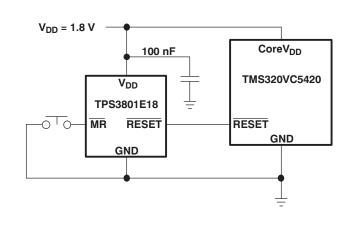
These devices assert a push-pull RESET signal when the SENSE (adjustable version) or V<sub>DD</sub> (fixed version) drops below a preset threshold. The RESET output remains asserted for the factory programmed delay time after the SENSE or V<sub>DD</sub> return above its threshold.

The TPS380x devices, except the TPS3801-01, incorporate a manual reset input (MR). A low level at MR causes RESET to become active.

The TPS380x uses a precision reference to achieve an overall threshold accuracy of 2%-2.5%. These devices are available in a 5-pin SC-70 package, which is only about half the size of a 5-pin SOT-23 package.

The TPS380x devices are fully specified over a temperature range of -40°C to +85°C.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# AVAILABLE OPTIONS(1)

T <sub>A</sub>	DEVICE NAME	THRESHOLD VOLTAGE	TYP DELAY TIME	MARKING
	TPS3801-01DCK	Adjustable ( $V_{ref} = 1.14 \text{ V}$ )	200 ms	ARF
	TPS3801E18DCK	1.71 V	200 ms	ARE
	TPS3801J25DCK	2.25 V	200 ms	NJA
	TPS3800G27DCK	2.5 V	95 ms	ARI
–40°C to 85°C	TPS3801L30DCK	2.64 V	200 ms	NPA
-40 C to 65 C	TPS3801K33DCK	2.93 V	200 ms	NWA
	TPS3802L30DCK	2.64 V	380 ms	ASA
	TPS3802K33DCK	2.93 V	380 ms	ARK
	TPS3801T50DCK	4.00 V	25 ms	AVI
	TPS3801I50DCK	4.55 V	200 ms	NSA

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or refer to our web site at www.ti.com.

# ABSOLUTE MAXIMUM RATINGS(1) (2)

Over operating free-air temperature range (unless otherwise noted).

	UNIT
Supply voltage, V <sub>DD</sub>	7 V
SENSE	–0.3 V to 5 V
All other pins	–0.3 V to 7 V
MR	-0.3 V to V <sub>DD</sub> + 0.3 V
RESET	-0.3 V to V <sub>DD</sub> + 0.3 V
Maximum low-output current, I <sub>OL</sub>	5 mA
Maximum high-output current, I <sub>OH</sub>	–5 mA
Input-clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{DD}$ )	±20 mA
Output-clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> )	±20 mA
Operating junction temperature range, T <sub>J</sub> <sup>(3)</sup>	-40°C to +85°C
Storage temperature range, T <sub>stg</sub>	−65°C to +150°C

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### RECOMMENDED OPERATING CONDITIONS

	LD OI ENATING CONDITIONS			
		MIN	MAX	UNIT
O	TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, TPS3801T50	2	6	V
Supply voltage, V <sub>DD</sub>	All other devices	1.6	4	V
SENSE		0	See (1)	V
Input voltage, V <sub>I</sub>		0	V <sub>DD</sub> +0.3	V
High-level input voltag	e, V <sub>IH</sub>	$0.7 \times V_{DD}$	V <sub>DD</sub> +0.3	V
Low-level input voltage	e, V <sub>IL</sub>		$0.3 \times V_{DD}$	V
Input transition rise an	d fall rate at MR, Δt/ΔV		100	ns/V
Pull-up resistor value,	RESET	V <sub>Pull-up</sub> 50μΑ		Ω
Operating free-air tem	perature range, T <sub>A</sub>	-40	+85	°C

(1) Maximum =  $V_{DD}$  + 0.3 or 4.5 V, whichever is greater.

<sup>(2)</sup> All voltage values are with respect to GND. For reliable operation, the device should not be operated at 7 V for more than t = 1000h continuously.

<sup>(3)</sup> Due to the low dissipation power of this device, it is assumed that  $T_J = T_A$ .



# **ELECTRICAL CHARACTERISTICS**

Over -40°C to +85°C free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS		xx, TPS3801- S3802-xx	×x,		
				MIN	TYP	MAX	UNIT	
			$V_{DD} = 1.6 \text{ V to 6 V I}_{OH} = -500 \mu\text{A}$	V <sub>DD</sub> -0.2				
$V_{OH}$	High-level output voltage	je (RESET)	$V_{DD} = 3.3 \text{ V } I_{OH} = -2 \text{ mA}$	V <sub>DD</sub> -0.4			V	
			$V_{DD} = 6 \text{ V } I_{OH} = -4 \text{ mA}^{(1)}$	V <sub>DD</sub> -0.4				
			$V_{DD} = 1.6 \text{ V to 6 V}, I_{OL} = 500 \mu\text{A}$			0.2		
$V_{OL}$	Low-level output voltag	e (RESET)	V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 2 mA			0.4	V	
			$V_{DD} = 6 \text{ V}, I_{OL} = 4 \text{ mA}^{(1)}$			0.4		
	Power-up reset voltage	(2)	$V_{DD} \ge 1.1 \text{ V}, I_{OL} = 50  \mu\text{A}$			0.2	V	
		TPS380x-01		1.117	1.14	1.163		
		TPS380xE18		1.67	1.71	1.75		
		TPS380xJ25		2.2	2.25	2.3		
. ,	Negative-going input	TPS380xG27	T 4000 to 0500	2.45	2.5	2.55		
$V_{IT-}$	threshold voltage (3)	TPS380xL30	$T_A = -40$ °C to 85°C	2.58	2.64	2.7	V	
			TPS380xK33		2.87	2.93	2.99	
			TPS380xI50		4.45	4.55	4.65	
		TPS380xT50		3.92	4	4.08		
	TPS380x-01			15				
	TPS380x: Threshold hysteresis TPS380x:	TPS380xx18			25			
		TPS380xx25			30			
$V_{hys}$		TPS380xx27			35		mV	
		TPS380xx30			35			
		TPS380xx33			40			
		TPS380xx50			60			
I <sub>IH</sub>	High-level input current	(MR)	$\overline{MR} = 0.7 \times V_{DD}, V_{DD} = 6 \text{ V}$	-40	-60	-100		
I <sub>IL</sub>	Low-level input current	(MR)	$\overline{MR} = 0 \text{ V}, \text{ V}_{DD} = 6 \text{ V}$	-130	-200	-340	μΑ	
l <sub>l</sub>	Input current (SENSE)			-25		25	nA	
		TPS3801J25, TPS3801L30,	V <sub>DD</sub> = 2 V, MR and output unconnected		9	12		
		TPS3801K33, TPS3801I50, TPS3801T50	$V_{DD} = 6 \text{ V}, \overline{\text{MR}} \text{ and output}$ unconnected		20	25		
	Supply current	Current TDC2004 24	$V_{DD}$ = 1.6 V, SENSE = 0 V to $V_{DD}$ , output unconnected		7	10	μА	
	pply current TPS3801-01	$V_{DD} = 4 \text{ V, SENSE} = 0 \text{ V to } V_{DD},$ output unconnected		9	12	·		
	TPS3801E18, TPS3800G27,	V <sub>DD</sub> = 1.6 V, MR and output unconnected		8	11			
		TPS3802K33, TPS3802L30	$V_{DD} = 4 \text{ V}, \overline{\text{MR}} \text{ and output}$ unconnected		13	18		
Ci	Input capacitance		$V_I = 0 V \text{ to } V_{DD}$		5		pF	

 <sup>(1)</sup> Only valid for the TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, and TPS3801T50.
 (2) The lowest supply voltage at which RESET becomes active. t<sub>r, VDD</sub> ≥ 15 μs/V.
 (3) To ensure the best stability of the threshold voltage, a bypass capacitor (0.1-μF ceramic) should be placed near the supply terminals.



# **TIMING REQUIREMENTS**

at  $R_L = 1 \text{ M}\Omega$ ,  $C_L = 50 \text{ pF}$ ,  $T_A = +25^{\circ}\text{C}$ 

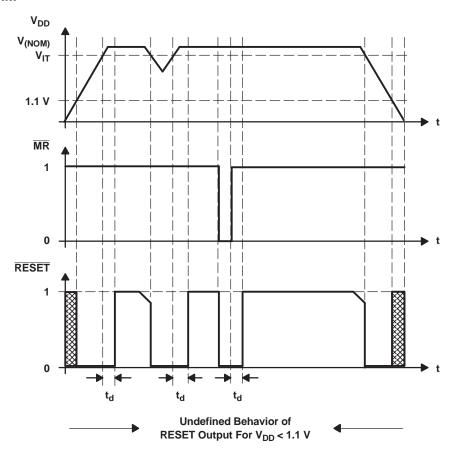
PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
		at SENSE	$V_{DD} = 1.6 \text{ V}, V_{IH} = 1.1 \times V_{IT-}, V_{IL} = 0.9 \times V_{IT-}$	1			0
t <sub>w</sub>	Pulse width	at V <sub>DD</sub>	$V_{DD} = V_{IT-} + 0.2 \text{ V}, V_{DD} = V_{IT-} -0.2 \text{ V}$	3	}		μS
		at MR	$V_{DD} \ge V_{IT-} + 0.2 \text{ V}, V_{IL} = 0.3 \times V_{DD}, V_{IH} = 0.7 \times V_{DD}$	100	)		ns

# **SWITCHING CHARACTERISTICS**

at  $R_1 = 1 \text{ M}\Omega$ ,  $C_1 = 50 \text{ pF}$ ,  $T_{\Delta} = +25^{\circ}\text{C}$ 

PARA	METER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
		TPS3801T50		15	25	35	
	DECET and a second delay the se	TPS3800	$V_{DD} \ge V_{IT} + 0.2 \text{ V},$	60	95	140	
t <sub>d</sub> RESET	RESET recovery delay time	TPS3801	MR ≥ 0.7 × V <sub>DD</sub> See timing diagram	120	200	280	ms
		TPS3802		240	380	560	
. Propagation (delay) time, high-to-low-lev		MR to RESET delay	$V_{DD} \ge V_{IT-} + 0.2 \text{ V},$ $V_{IL} = 0.3 \times V_{DD},$ $V_{IH} = 0.7 \times V_{DD}$		15		ns
t <sub>PHL</sub>	output	V <sub>DD</sub> to RESET delay SENSE to RESET	$V_{IL} = V_{IT-} - 0.2 \text{ V},$ $V_{IH} = V_{IT-} + 0.2 \text{ V}$		1		μS

# **TIMING DIAGRAM**



NOTE:  $\overline{\text{RESET}}$  should not be forced high during the power-up sequence (until  $V_{DD} > 1.1 \text{ V}$ ).



# **FUNCTIONAL BLOCK DIAGRAMS**

# FUNCTION/TRUTH TABLE, TPS380x

MR	$V_{DD}>V_{IT}$	RESET
L	0	L
L	1	L
н	0	L
н	1	н

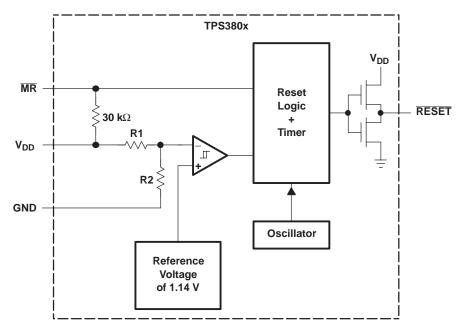


Figure 1.

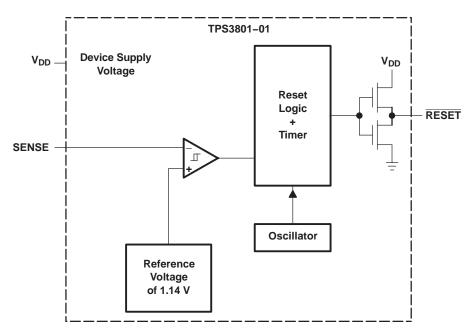
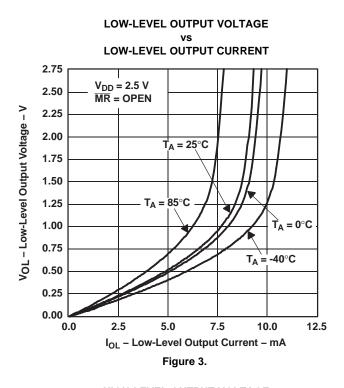
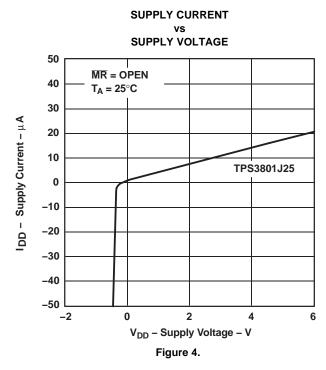


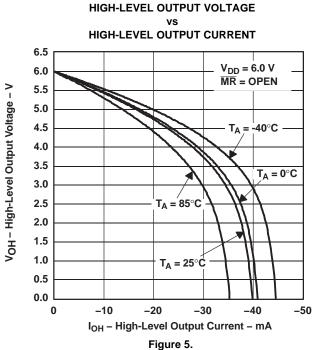
Figure 2.

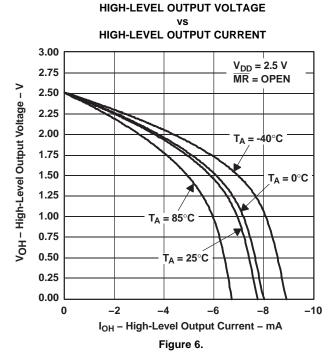


#### TYPICAL CHARACTERISTICS



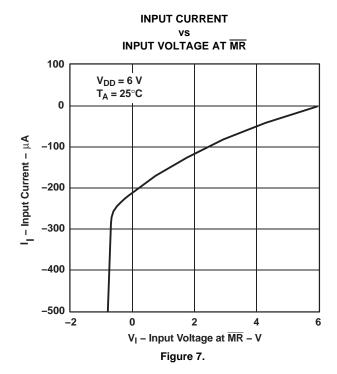




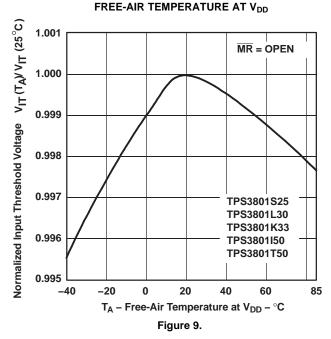




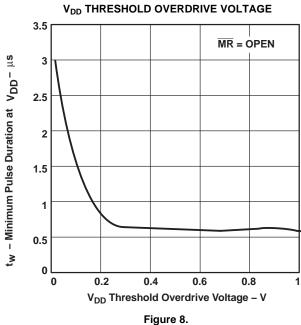
# TYPICAL CHARACTERISTICS (continued)



# NORMALIZED INPUT THRESHOLD VOLTAGE vs



# 



# NORMALIZED INPUT THRESHOLD VOLTAGE vs

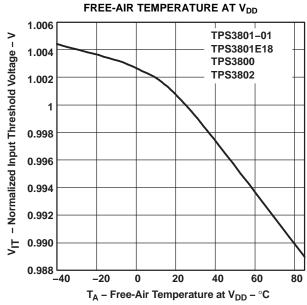
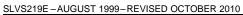


Figure 10.





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Ch	anges from Revision D (December 2006) to Revision E	Page
•	Added Pull-up resistor value, RESET to the Recommended Operating Conditions Table	2

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#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3800G27DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARI	Samples
TPS3801-01DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARF	Samples
TPS3801E18DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARE	Samples
TPS3801I50DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NSA	Samples
TPS3801J25DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NJA	Samples
TPS3801K33DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NWA	Samples
TPS3801L30DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NPA	Samples
TPS3801T50DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVI	Samples
TPS3802K33DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARK	Samples
TPS3802L30DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ASA	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



# **PACKAGE OPTION ADDENDUM**

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3800G27DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801-01DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801E18DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801I50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801J25DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3802K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3802L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3



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\*All dimensions are nominal

All difficultions are norminal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3800G27DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801-01DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801E18DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801I50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801J25DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801T50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3802K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3802L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0



SMALL OUTLINE TRANSISTOR



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 10. Board assembly site may have different recommendations for stencil design.



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